



PROCESS CHANGE NOTIFICATION

PCN2214

Inductor Change in selected Enpirion Power SoC Devices

Change Description:

Intel® is notifying customers about a change of inductor in selected Intel Enpirion® PowerSoC Devices. There are no changes to form, fit and function. Qualification will be performed that includes reliability and device performance assessment.

Table 1: Change Details

	Change From	Change To
Supplier	Maglayers	FDK
Size Dimension	3.2 mm X 2.6 mm	3.2 mm X 2.5 mm
Thickness	Max 0.7mm	Max 0.75 mm
Inductor Value	1.1 uH	1.0 uH
DC Resistance	0.11	0.055
Rs@5Mhz	2	0.5 typ
Current	1.0A max	1.5A Sat
Material	Multi-layer Ferrite Chip Inductor	Multi-layer Power Inductor
SRF	70 Mhz	90Mhz Typ
Inductance Tolerance	20%	25%
Termination Finish	Not specified (typ Ni/Sn)	Ag+ Ni/Sn

Note: The rest of the Bill of Material (BOM) remains the same

Products Affected:

Table 2

Product Family	Part Number
Enpirion Power SoC	EN5311QI
	EN5311QI-C
	EP5352QI
	EP5362QI
	EP5382QI

Recommended Action

Customers are requested to:

1. Acknowledge receipt of this notification.
2. Review and inform us, at the earliest convenience, of any questions or concerns regarding this change.

Please refer to the "Product Transition Dates" for the key milestones.

Upon implementation, Intel will ship either pre-change or post-change materials.

Product Transition Dates:

Customers are requested to take note of the key dates shown in the table below.

Table 3: Key Dates

<i>Milestone</i>	<i>Date</i>
Last date to acknowledge receipt of this notification ¹	July 22, 2022
Earliest change implementation	Dec 15, 2022

Note 1: J-STD-046, section 3.2.3.1b, stipulates that lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.

Reason for Change:

The supplier has issued a discontinuance notification of the existing inductor. The qualification of the new inductor will enable fulfillment of the last time buy orders of these selected Enpirion devices (Refer to related [PDN2133](#))

Impact and Benefit of Change:

There is no impact to form, fit, function. Qualification will be performed for reliability and device performance assessment and to meet existing electrical and mechanical specifications.

(See Qualification Plan Section, Table 4).

Qualification Plan:

Testing estimated to complete by August 2022.

Vehicle device: EN5311QI.

Table 4: Reliability Test Plan

Test	Time point	Conditions	Standard	# of Lots
Temperature Cycle (TC) with Pre-conditioning (MSL3)	1000 Cycles	-55°C /125°C	JESD22-A104	3 lots/231 units
Device Validation Test	N/A	Vin=Vinmin to Vinmax Load= Loadmin to Loadmax Temp= -40C to +85 C	N/A	3 lots/30 units
Unbiased Highly Accelerated Stress Test (uHAST) with Pre-conditioning (MSL3)	96hrs	130°C / 85%RH	JESD22-A118	3 lots/231 units

High Temp Storage (HTS) with Pre-conditioning (MSL3)	1000hrs	150°C	JESD22-A103	3 lots/231 units
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Contact

For more information, please contact Sales in your region, or submit a Service Request at the [My Intel](#) support page.

Revision History

Date	Rev	Description
04/15/2022	1.0.0	Initial Release

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